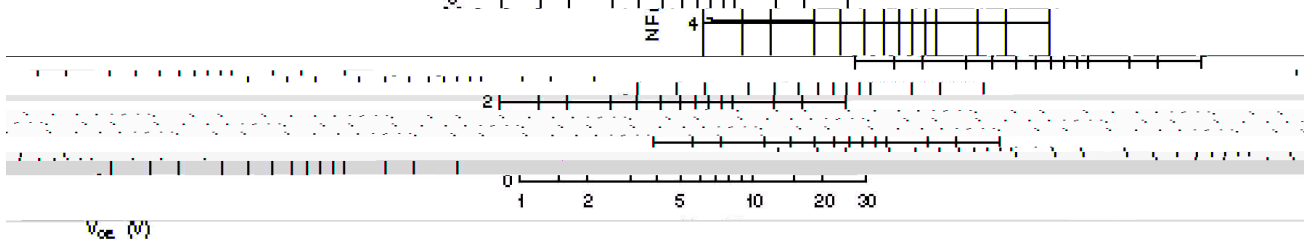
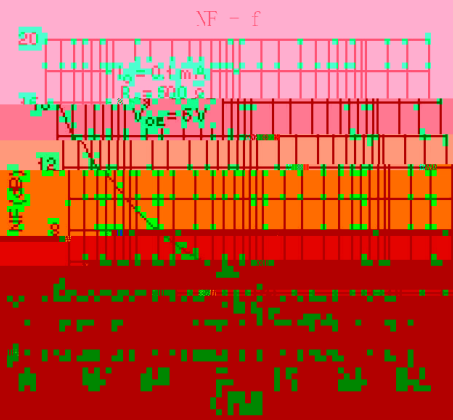
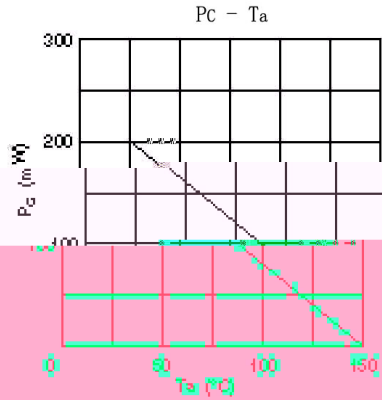


**2SC2308**  
Rev.E Mar.-2016

KF \$0)      E GE '      Silicon NPN transistor in



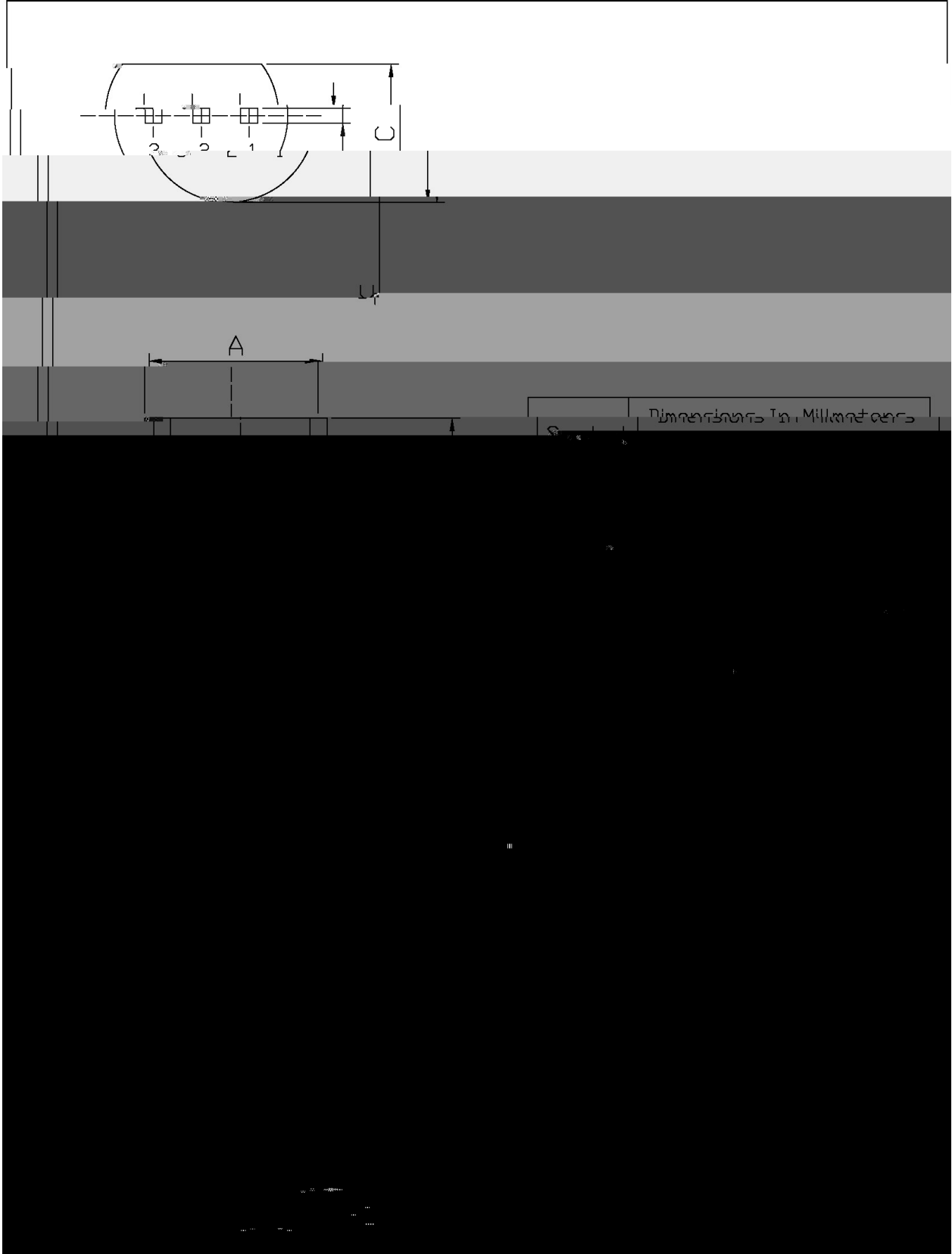
/ Electrical Characteristic Curve



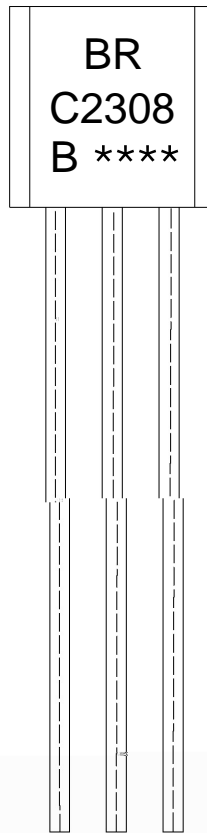
/ Package Dimensions

T0-92

Unit: mm



/ Marking Instructions



91 1  
: ) \*' /  
91  
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Note:

- BR: Company Code.
- C2308: Product Type.
- B:  $h_{FE}$  Classifications Symbol
- \*\*\*\*: Lot No. Code, code change with Lot No.

**( ) / Temperature Profile for Dip Soldering(Pb-Free)**



1	25	150	60	90sec;	Note:	1.Preheating:25~150 , Time:60~90sec.
2	255..5		5..0.5sec;		2.Peak Temp.:255..5 , Duration:5..0.5sec.	
3		2	10	/sec.	3. Cooling Speed: 2~10 /sec.	

**/ Resistance to Soldering Heat Test Conditions**

270..5                      10..1 sec.                      Temp:270±5                      Time:10±1 sec

**/ Packaging SPEC.**

/ BULK

Package Type	Units	Dimension	(unit mm3)
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